



N-Channel + P Channel Logic Level Enhancement Mode Field Effect Transistor

▪ Product Summary:

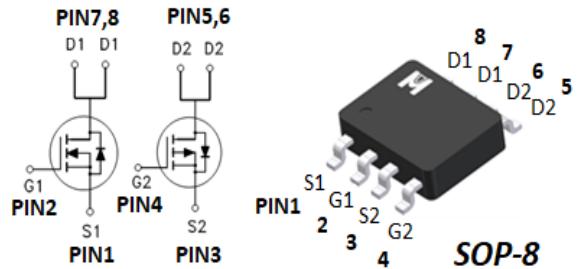
	N-CH	P-CH
BVDSS	30 V	-30 V
R <sub>DSON</sub> (MAX.) @ V <sub>GS</sub> = 10V	18 mΩ	22 mΩ
R <sub>DSON</sub> (MAX.) @ V <sub>GS</sub> = 4.5V	26 mΩ	37 mΩ
I <sub>D</sub> @ T <sub>C</sub> = 25 °C	12 A	-12 A
I <sub>D</sub> @ T <sub>A</sub> = 25 °C	8 A	-7 A

N Channel + P Channel MOSFET

UIS, Rg 100% Tested

Pb-Free Lead Plating & Halogen Free

▪ Pin Description:



▪ ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS		UNIT
		N-CH	P-CH	
Gate-Source Voltage	V <sub>GS</sub>	±20	±20	V
Continuous Drain Current	T <sub>C</sub> = 25 °C	I <sub>D</sub>	12	A
	T <sub>C</sub> = 100 °C		8	
Continuous Drain Current	T <sub>A</sub> = 25 °C	I <sub>D</sub>	8	A
	T <sub>A</sub> = 70 °C		6	
Pulsed Drain Current <sup>1</sup>	I <sub>DM</sub>	32	-28	
Avalanche Current	I <sub>AS</sub>	22	-30	
Avalanche Energy	L = 0.1mH	EAS	24.2	mJ
Repetitive Avalanche Energy <sup>2</sup>	L = 0.05mH	EAR	12.1	
Power Dissipation	T <sub>C</sub> = 25 °C	P <sub>D</sub>	5	W
	T <sub>C</sub> = 100 °C		2	
Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2	W
	T <sub>A</sub> = 70 °C		1.3	
Operating Junction & Storage Temperature Range	T <sub>j</sub> , T <sub>stg</sub>	-55 to 150		°C

▪ THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM		UNIT
			N-CH	P-CH	
Junction-to-Case	R <sub>θJC</sub>		25	25	
Junction-to-Ambient <sup>3</sup>	R <sub>θJA</sub>		62.5	62.5	°C/W

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>Duty cycle < 1%

<sup>3</sup>62.5 °C / W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

<sup>4</sup>Guarantee by Engineering test

**▪ N-CH\_ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Noted)**

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage <sup>4</sup>	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	30			V
Gate Threshold Voltage <sup>4</sup>	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.5	1.8	3	
Gate-Body Leakage <sup>4</sup>	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 20V$			$\pm 100$	nA
Zero Gate Voltage Drain Current <sup>4</sup>	$I_{DSS}$	$V_{DS} = 24V, V_{GS} = 0V$			1	uA
		$V_{DS} = 20V, V_{GS} = 0V, T_J = 125^\circ\text{C}$			25	
On-State Drain Current <sup>1</sup>	$I_{D(\text{ON})}$	$V_{DS} = 10V, V_{GS} = 10V$	12			A
Drain-Source On-State Resistance <sup>1,4</sup>	$R_{DS(\text{ON})}$	$V_{GS} = 10V, I_D = 10A$		15	18	mΩ
		$V_{GS} = 4.5V, I_D = 6A$		21	26	
<b>DYNAMIC</b>						
Input Capacitance <sup>5</sup>	$C_{iss}$	$V_{GS} = 0V, V_{DS} = 15V, f = 1\text{MHz}$		727		pF
Output Capacitance <sup>5</sup>	$C_{oss}$			123		
Reverse Transfer Capacitance <sup>5</sup>	$C_{rss}$			107		
Gate Resistance <sup>4,5</sup>	$R_g$	$f = 1\text{MHz}$		1.4		Ω
Total Gate Charge <sup>1,2,5</sup>	$Q_g(V_{GS}=10V)$	$V_{DS} = 15V, V_{GS} = 10V, I_D = 10A$		16.0		nC
	$Q_g(V_{GS}=4.5V)$			8.8		
Gate-Source Charge <sup>1,2,5</sup>	$Q_{gs}$			2.0		
Gate-Drain Charge <sup>1,2,5</sup>	$Q_{gd}$			4.8		
Turn-On Delay Time <sup>1,2,5</sup>	$t_{d(on)}$	$V_{DS} = 15V, V_{GS} = 10V, I_D = 5A, R_g = 6\Omega$		6.7		nS
Rise Time <sup>1,2,5</sup>	$t_r$			12.2		
Turn-Off Delay Time <sup>1,2,5</sup>	$t_{d(off)}$			21.4		
Fall Time <sup>1,2,5</sup>	$t_f$			16.2		
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Continuous Current	$I_S$				12	A
Pulsed Current <sup>3</sup>	$I_{SM}$				32	
Forward Voltage <sup>1,4</sup>	$V_{SD}$	$I_F = 15A, V_{GS} = 0V$			1.2	V
Reverse Recovery Time <sup>5</sup>	$t_{rr}$	$I_F = 15A, dI_F/dt = 100A/\mu\text{s}$		10.3		nS
Reverse Recovery Charge <sup>5</sup>	$Q_{rr}$			4.3		nC

<sup>1</sup>Pulse test : Pulse Width  $\leq 300$  usec, Duty Cycle  $\leq 2\%$ .

<sup>2</sup>Independent of operating temperature.

<sup>3</sup>Pulse width limited by maximum junction temperature.

<sup>4</sup>Guarantee by FT test Item

<sup>5</sup>Guarantee by Engineering test

**EMC will review datasheet by quarter, and update new version.**



▪ TYPICAL CHARACTERISTICS

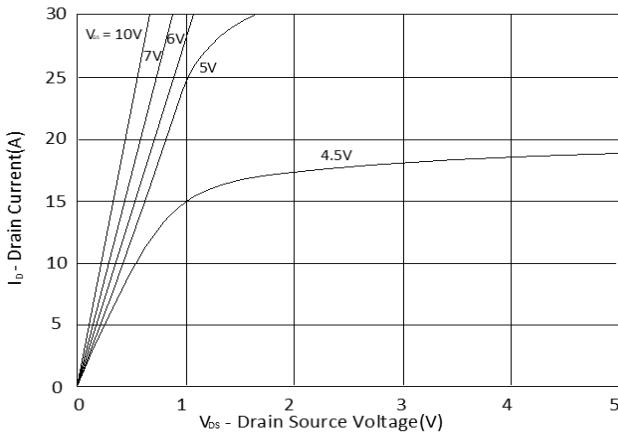


Fig.1 Typical Output Characteristics

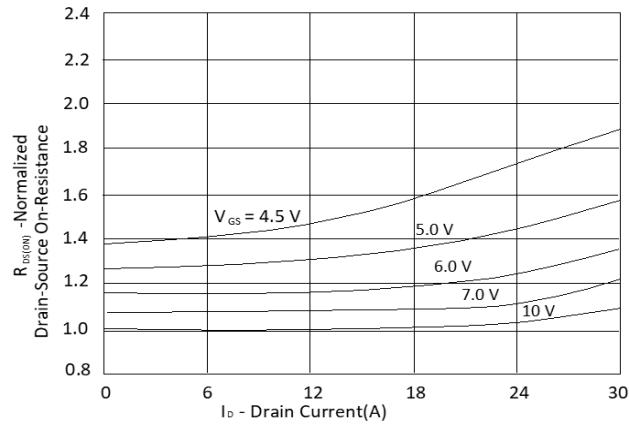


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

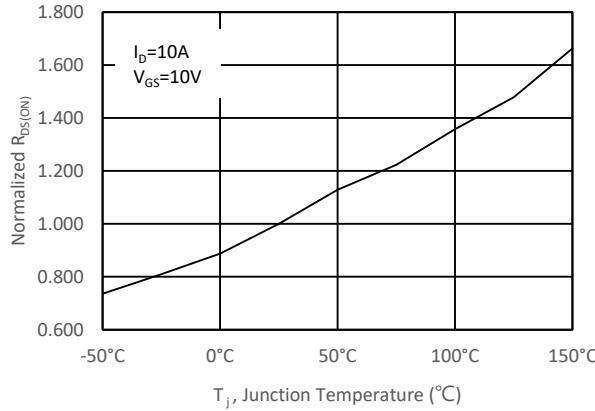


Fig.3 Normalized On-Resistance v.s. Junction Temperature

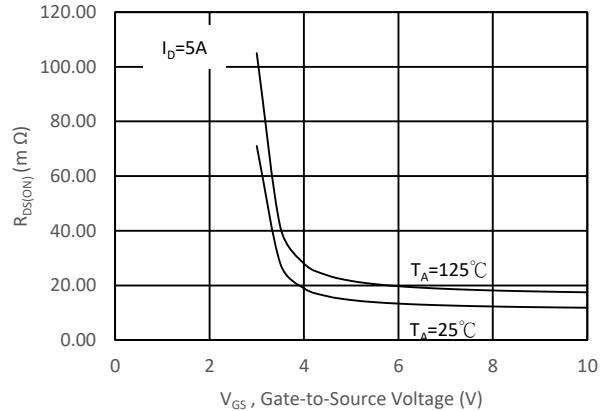


Fig.4 On-Resistance v.s. Gate Voltage

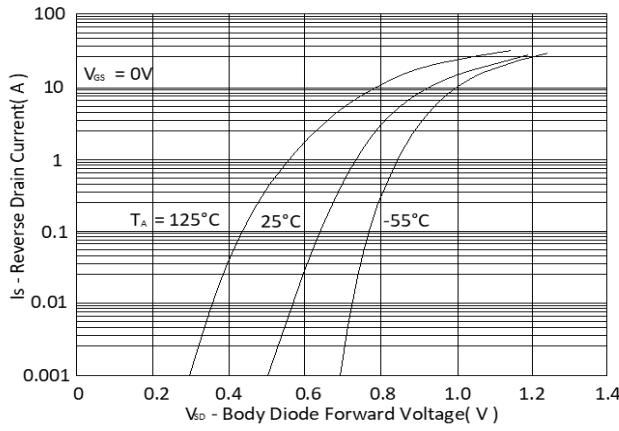


Fig.5 Forward Characteristic of Reverse Diode

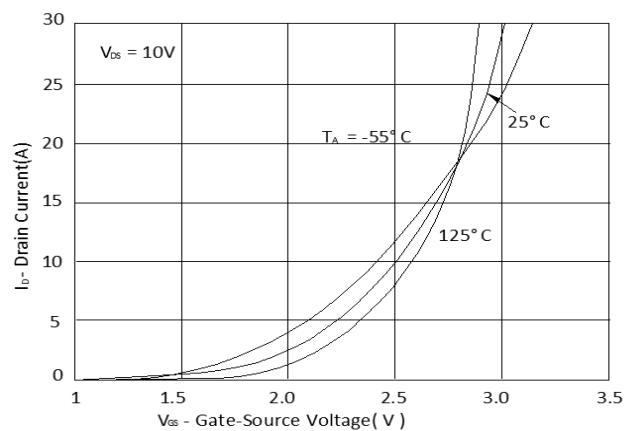
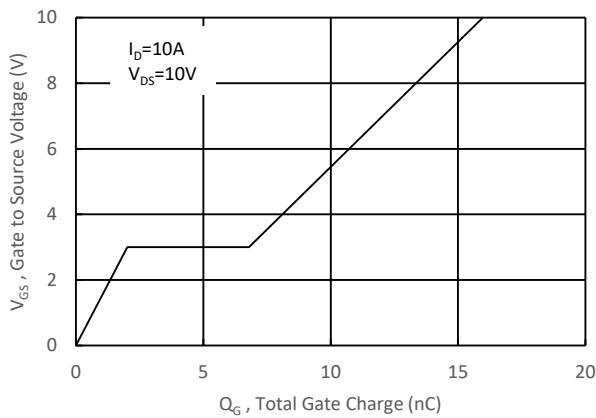
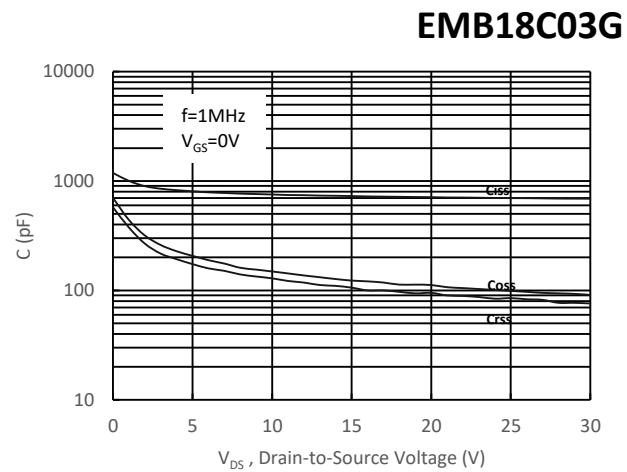


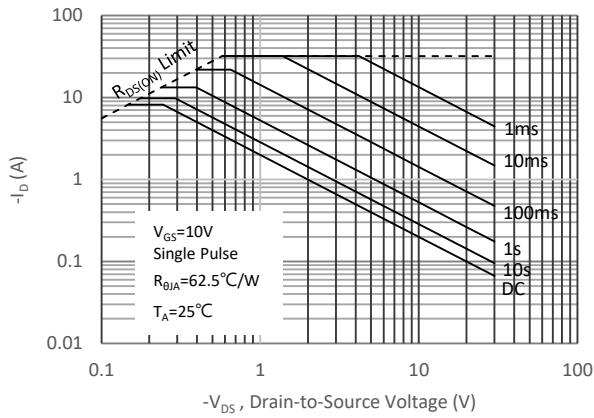
Fig.6 Transfer Characteristics



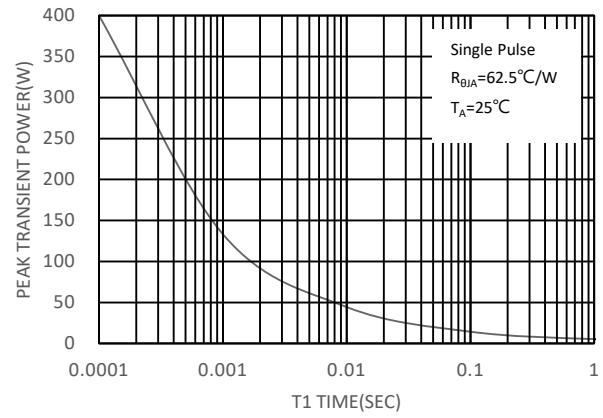
**Fig.7 Gate Charge Characteristics**



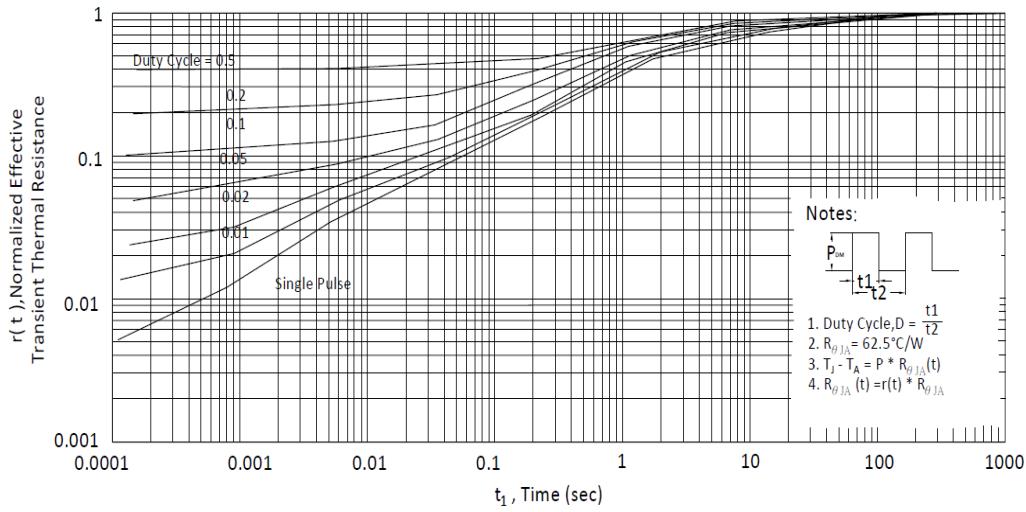
**Fig.8 Typical Capacitance Characteristics**



**Fig.9. Maximum Safe Operating Area**



**Fig 10. Single Pulse Maximum Power Dissipation**



**Fig 11. Effective Transient Thermal Impedance**



▪ P-CH\_ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage <sup>4</sup>	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = -250\mu\text{A}$	-30			V
Gate Threshold Voltage <sup>4</sup>	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-1.5	-2.0	-3.0	
Gate-Body Leakage <sup>4</sup>	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 20V$			$\pm 100$	nA
Zero Gate Voltage Drain Current <sup>4</sup>	$I_{DSS}$	$V_{DS} = -24V, V_{GS} = 0V$			-1	uA
		$V_{DS} = -20V, V_{GS} = 0V, T_J = 125^\circ\text{C}$			-25	
On-State Drain Current <sup>1</sup>	$I_{D(\text{ON})}$	$V_{DS} = -5V, V_{GS} = -10V$	-12			A
Drain-Source On-State Resistance <sup>1,4</sup>	$R_{DS(\text{ON})}$	$V_{GS} = -10V, I_D = -8A$		18	22	mΩ
		$V_{GS} = -4.5V, I_D = -6A$		28	37	
<b>DYNAMIC</b>						
Input Capacitance <sup>5</sup>	$C_{iss}$	$V_{GS} = 0V, V_{DS} = -15V, f = 1\text{MHz}$		775		pF
Output Capacitance <sup>5</sup>	$C_{oss}$			126		
Reverse Transfer Capacitance <sup>5</sup>	$C_{rss}$			100		
Gate Resistance <sup>4,5</sup>	$R_g$	$f = 1\text{MHz}$		5.2		Ω
Total Gate Charge <sup>1,2,5</sup>	$Q_g(V_{GS}=10V)$	$V_{DS} = -15V, V_{GS} = -10V, I_D = -8A$		14.6		nC
	$Q_g(V_{GS}=4.5V)$			7.8		
Gate-Source Charge <sup>1,2,5</sup>	$Q_{gs}$			2.3		
Gate-Drain Charge <sup>1,2,5</sup>	$Q_{gd}$			3.8		
Turn-On Delay Time <sup>1,2,5</sup>	$t_{d(\text{on})}$	$V_{DS} = -15V, V_{GS} = -10V, I_D = -5A, R_g = 6\Omega$		6.5		nS
Rise Time <sup>1,2,5</sup>	$t_r$			14.0		
Turn-Off Delay Time <sup>1,2,5</sup>	$t_{d(\text{off})}$			27.9		
Fall Time <sup>1,2,5</sup>	$t_f$			24.5		
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Continuous Current	$I_S$				-12	A
Pulsed Current <sup>3</sup>	$I_{SM}$				-28	
Forward Voltage <sup>1,4</sup>	$V_{SD}$	$I_F = -15A, V_{GS} = 0V$			-1.2	V
Reverse Recovery Time <sup>5</sup>	$t_{rr}$	$I_F = -15A, dI_F/dt = 100A/\mu\text{s}$		6.7		nS
Reverse Recovery Charge <sup>5</sup>	$Q_{rr}$			2.4		

<sup>1</sup>Pulse test : Pulse Width  $\leq 300$  usec, Duty Cycle  $\leq 2\%$ .

<sup>2</sup>Independent of operating temperature.

<sup>3</sup>Pulse width limited by maximum junction temperature.

<sup>4</sup>Guarantee by FT test Item

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▪ TYPICAL CHARACTERISTICS

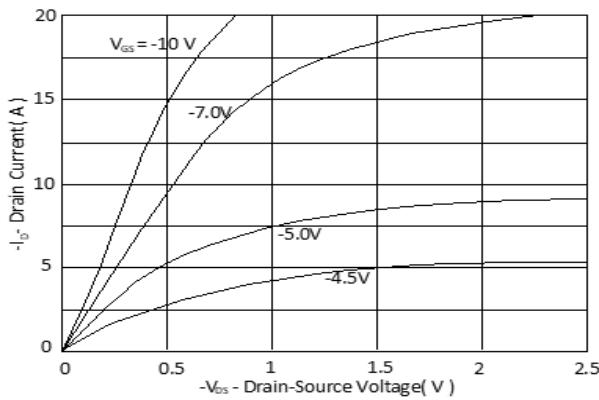


Fig.1 Typical Output Characteristics

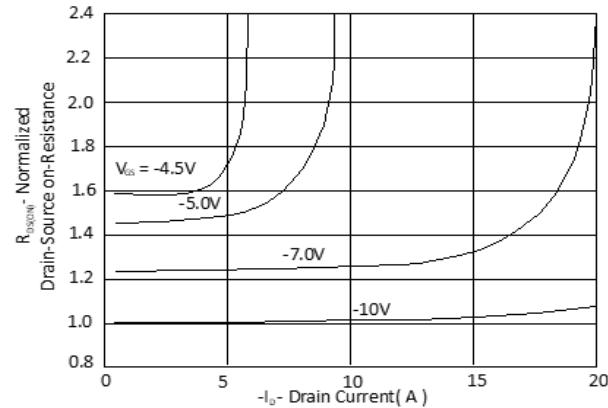


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

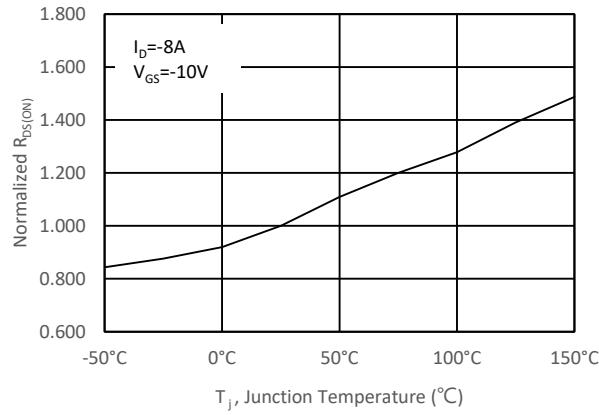


Fig.3 Normalized On-Resistance v.s. Junction Temperature

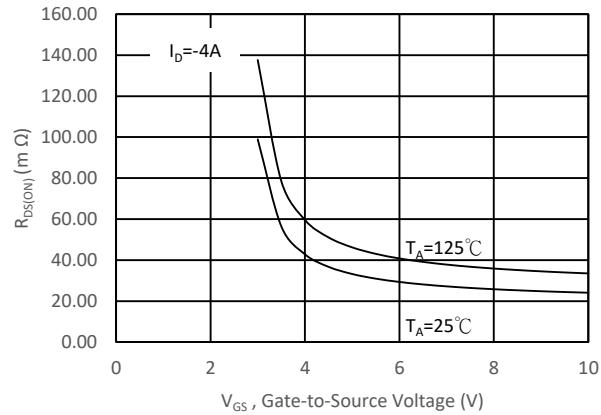


Fig.4 On-Resistance v.s. Gate Voltage

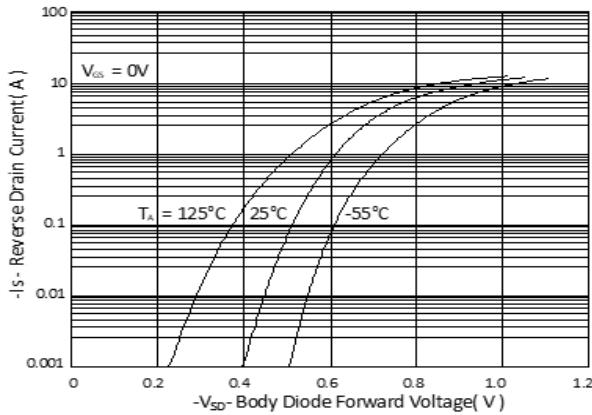


Fig.5 Forward Characteristic of Reverse Diode

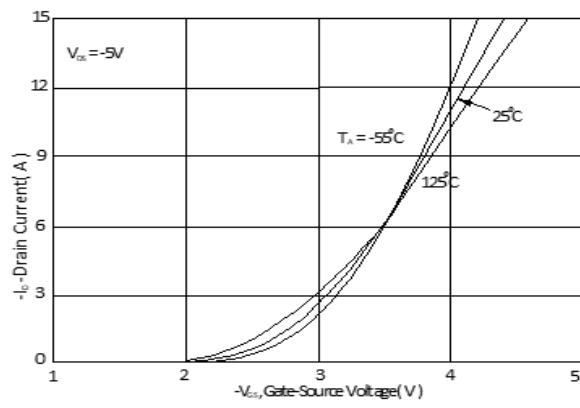


Fig.6 Transfer Characteristics

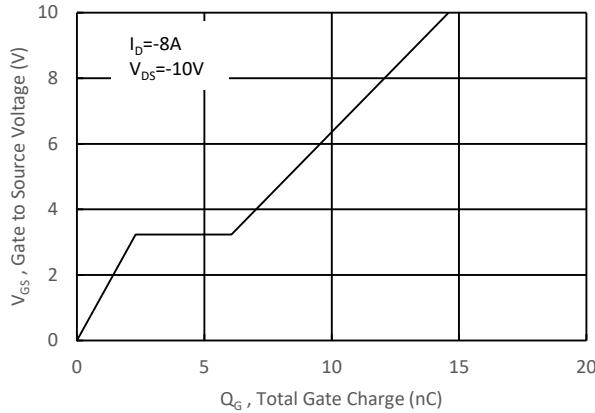


Fig.7 Gate Charge Characteristics

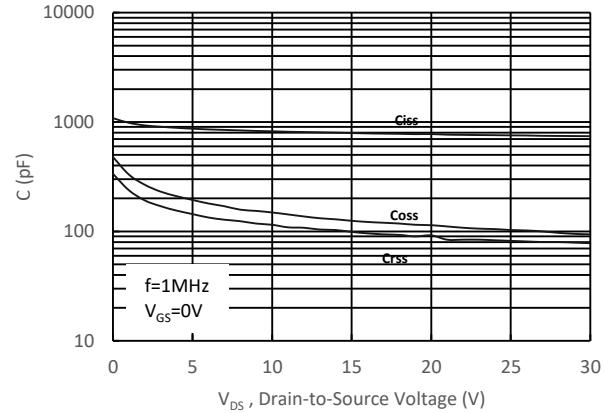


Fig.8 Typical Capacitance Characteristics

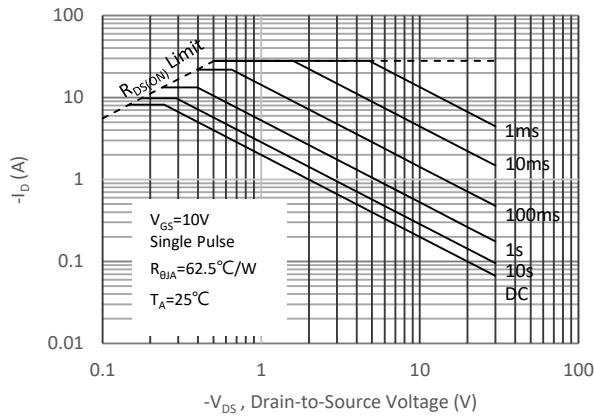


Fig.9. Maximum Safe Operating Area

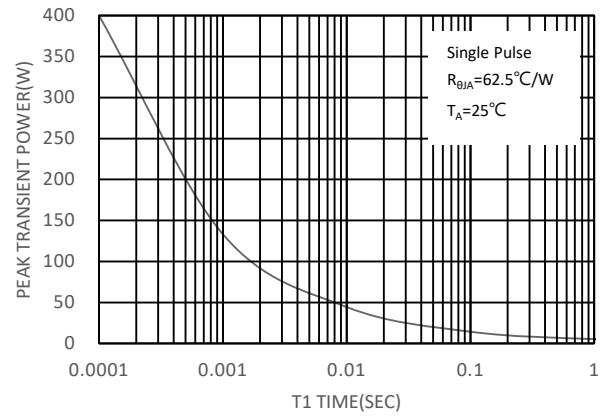


Fig 10. Single Pulse Maximum Power Dissipation

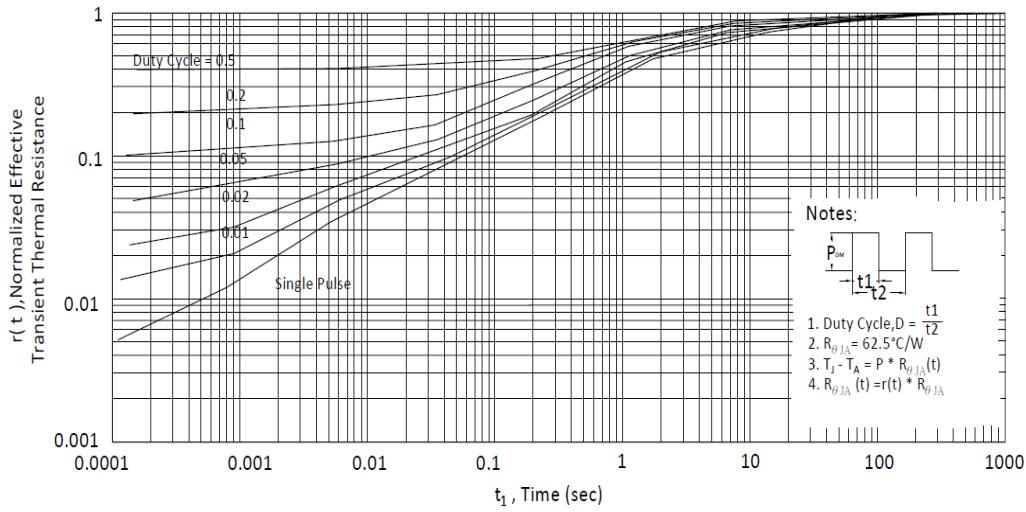
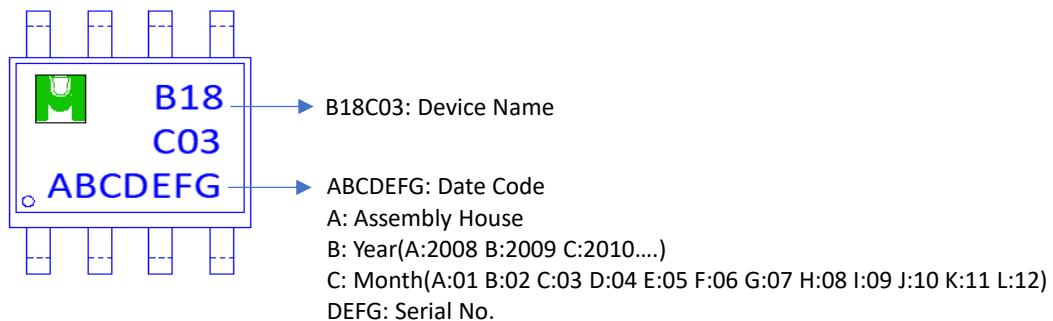


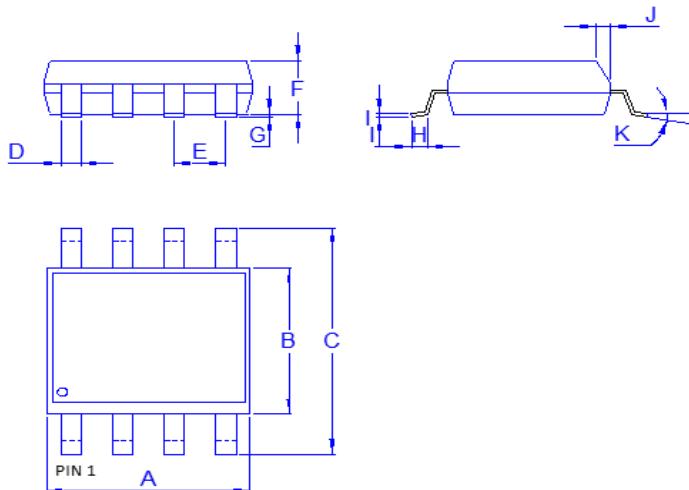
Fig 11. Effective Transient Thermal Impedance

**Ordering & Marking Information:**

Device Name: EMB18C03G for SOP-8

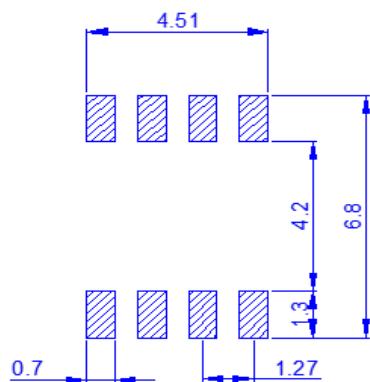


**Outline Drawing**



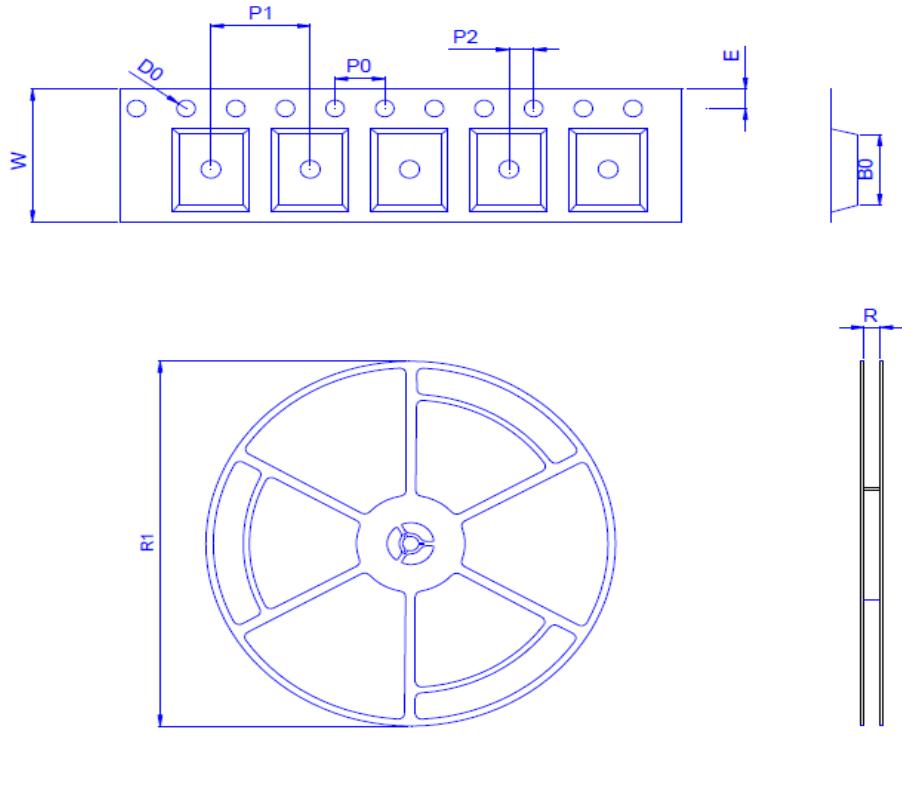
Dimension	A	B	C	D	E	F	G	H	I	J	K
Min.	4.7	3.8	5.8	0.31		1.35	0.01	0.4	0.1	0.25	0°
Typ.	4.9	3.9	6	0.41	1.27	1.55	0.18	0.6	0.2	0.3	
Max.	5.1	4	6.2	0.51		1.75	0.25	1.27	0.25	0.5	8°

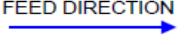
**Footprint**





◆ Tape&Reel Information:2500pcs/Reel



產品別	(P)SOP-8
Reel 尺寸	13"
編帶方式	FEED DIRECTION  

Dimension in mm

Dimension	Carrier tape							Reel	
	B0	D0	E	P0	P1	P2	W	R	R1
Typ.	6.50	1.50	1.75	4.00	8.00	2.00	12.00	12.40	330.00
±	0.40	0.20	0.20	0.20	0.20	0.20	0.50	REF	REF